



**Alfa-MOS  
Technology**

**AFP3679S  
30V P-Channel  
Enhancement Mode MOSFET**

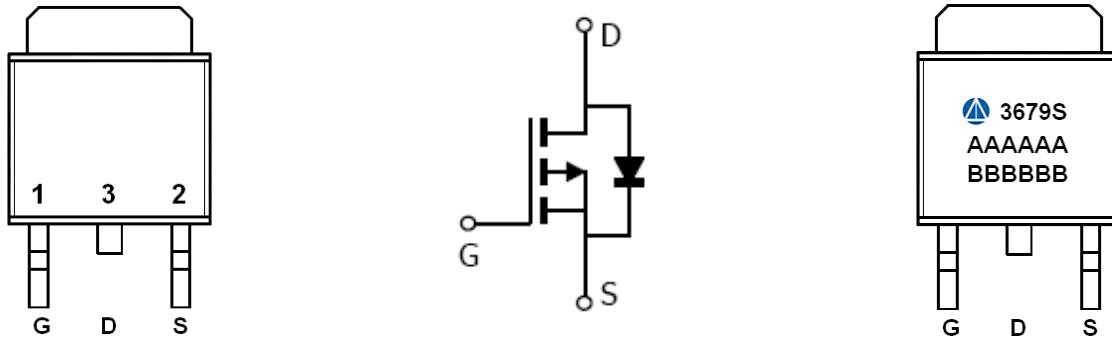
## General Description

AFP3679S, P-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent  $R_{DS(ON)}$ , low gate charge. These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

## Features

- -30V/-20A,  $R_{DS(ON)}=10m\Omega$  @  $V_{GS}=-10V$
- -30V/-15A,  $R_{DS(ON)}=15m\Omega$  @  $V_{GS}=-4.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- TO-252-2L package design

## Pin Description ( TO-252-2L )



## Application

- Power Switch
- Load Switch in High Current Applications
- DC/DC Converters

## Pin Define

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

## Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFP3679ST252RG	3679S	TO-252-2L	Tape & Reel	2500 EA

※ A Lot code

※ B Date code

※ AFP3679ST252RG : 13" Tape & Reel ; Pb- Free ; Halogen -Free



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### Absolute Maximum Ratings

( $T_A=25^\circ\text{C}$  Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	$V_{DSS}$	-30	V
Gate -Source Voltage	$V_{GSS}$	$\pm 20$	V
Continuous Drain Current( $T_J=150^\circ\text{C}$ )	$I_D$	-20.0	A
$T_A=70^\circ\text{C}$		-15.0	
Pulsed Drain Current	$I_{DM}$	-200	A
Continuous Source Current(Diode Conduction)	$I_S$	-9.0	A
Power Dissipation	$P_D$	40	W
$T_A=70^\circ\text{C}$		15	
Operating Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55/150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient	$R_{eJA}$	62.5	$^\circ\text{C}/\text{W}$

### Electrical Characteristics

( $T_A=25^\circ\text{C}$  Unless otherwise noted)

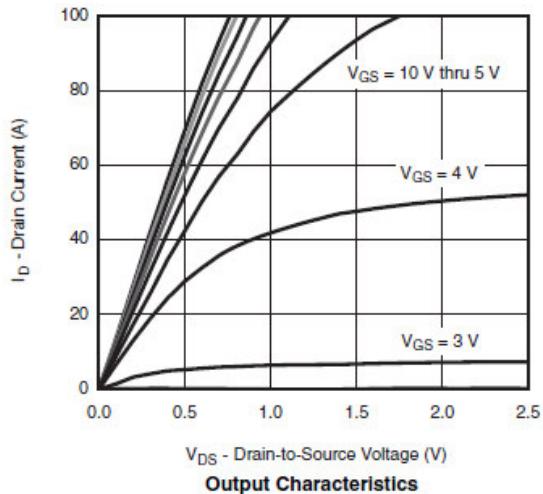
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-30			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-1.0		-3.0	
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=-24\text{V}, V_{GS}=0\text{V}$			-1	uA
		$V_{DS}=-24\text{V}, V_{GS}=0\text{V}$ $T_A=85^\circ\text{C}$			-30	
On-State Drain Current	$I_{D(\text{on})}$	$V_{DS} \leq -5\text{V}, V_{GS}=-10\text{V}$	-50			A
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS}=-10.0\text{V}, I_D=-20\text{A}$		8.5	10	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}, I_D=-15\text{A}$		12.5	15	
Forward Transconductance	$g_{FS}$	$V_{DS}=-15\text{V}, I_D=-20\text{A}$		45		S
Diode Forward Voltage	$V_{SD}$	$I_S=1.0\text{A}, V_{GS}=0\text{V}$		-0.7	-1.3	V
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=-15\text{V}, V_{GS}=-10\text{V}$ $I_D=-20\text{A}$		55	85	nC
Gate-Source Charge	$Q_{gs}$			9		
Gate-Drain Charge	$Q_{gd}$			12		
Input Capacitance	$C_{iss}$	$V_{DS}=-15\text{V}, V_{GS}=0\text{V}$ $f=1\text{MHz}$		2450		pF
Output Capacitance	$C_{oss}$			495		
Reverse Transfer Capacitance	$C_{rss}$			415		
Turn-On Time	$t_{d(on)}$	$V_{DD}=-15\text{V}, R_L=1.5\Omega$ $I_D=10\text{A}, V_{GEN}=-10\text{V}$		10	20	ns
	$t_r$			10	20	
Turn-Off Time	$t_{d(off)}$			30	50	
	$t_f$			10	20	



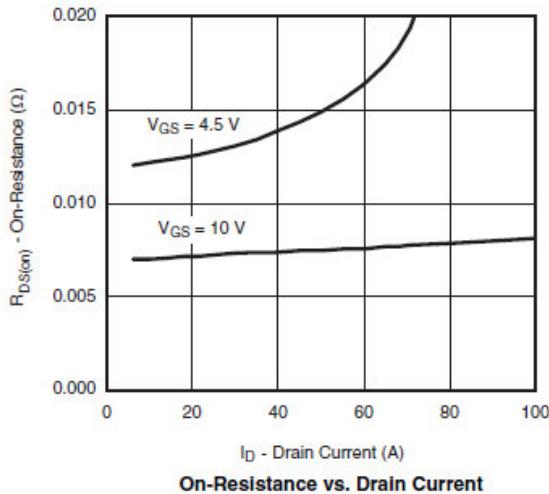
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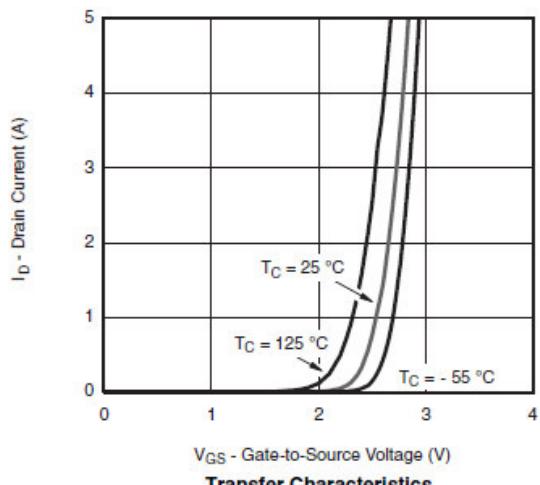
## Typical Characteristics



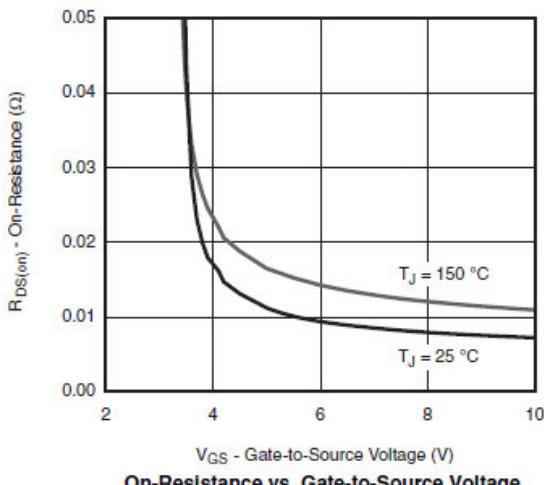
Output Characteristics



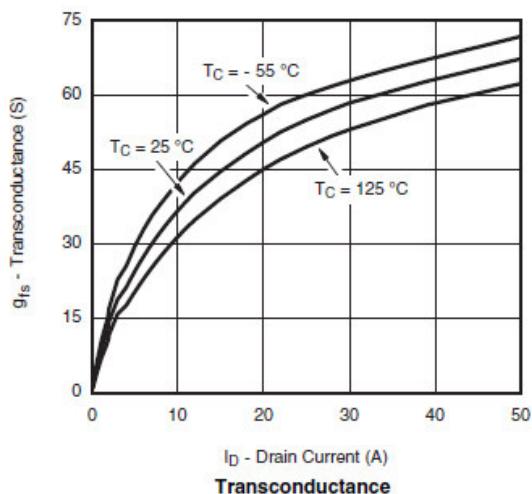
On-Resistance vs. Drain Current



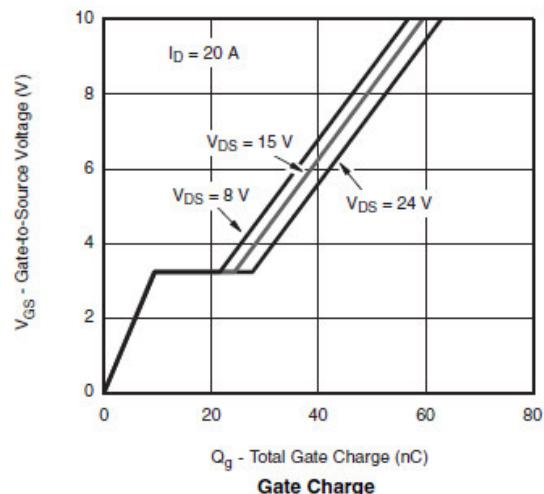
Transfer Characteristics



On-Resistance vs. Gate-to-Source Voltage



Transconductance



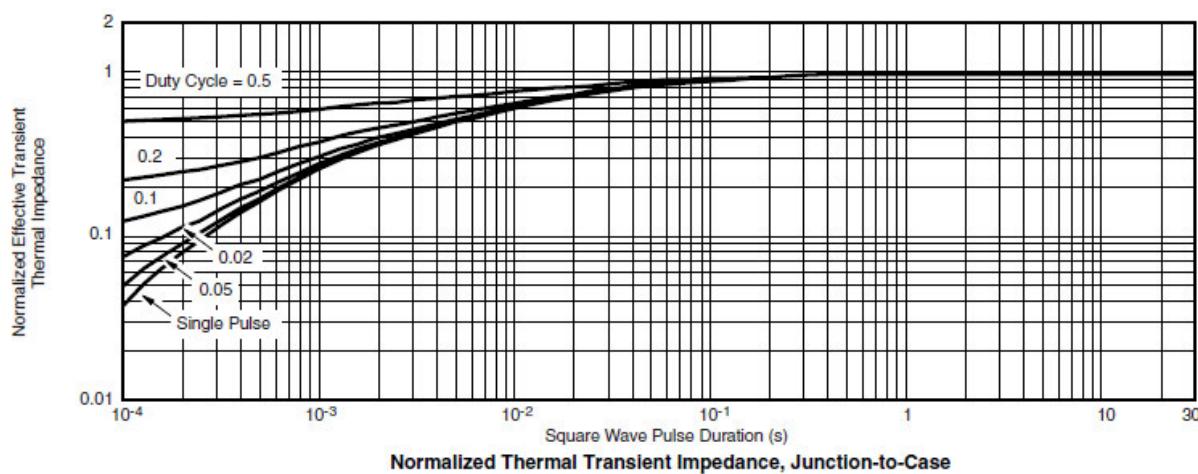
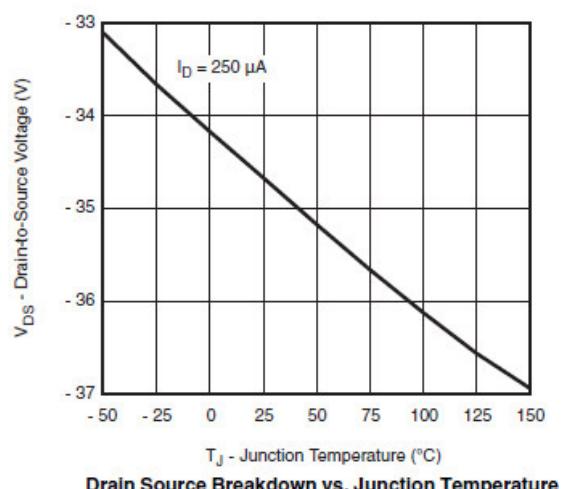
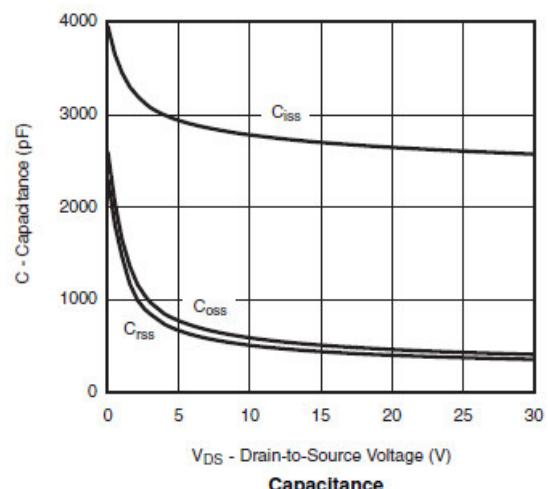
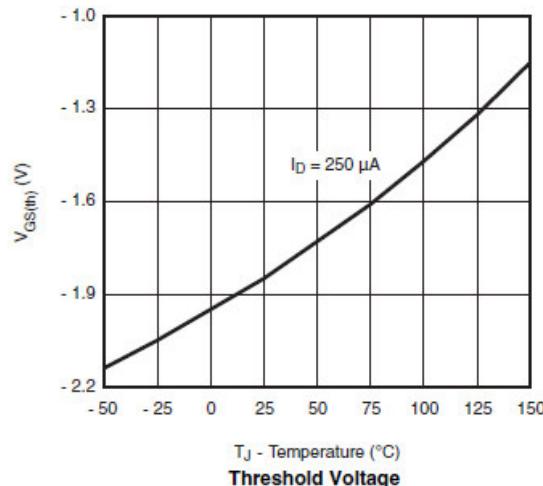
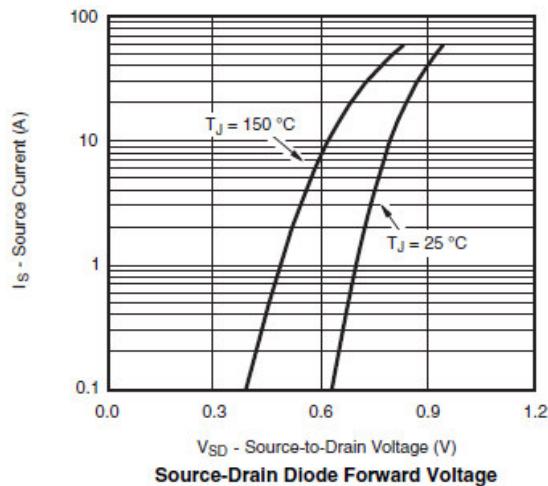
Gate Charge



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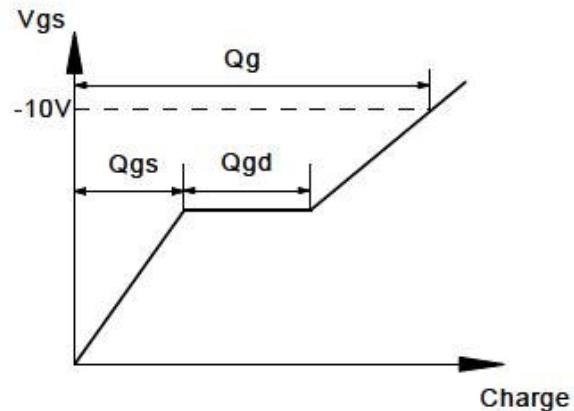
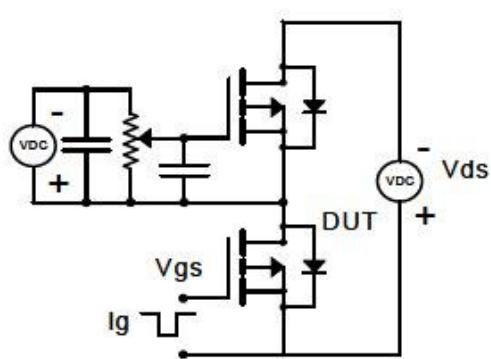


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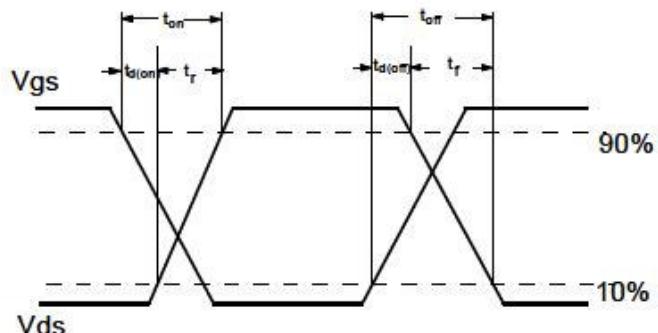
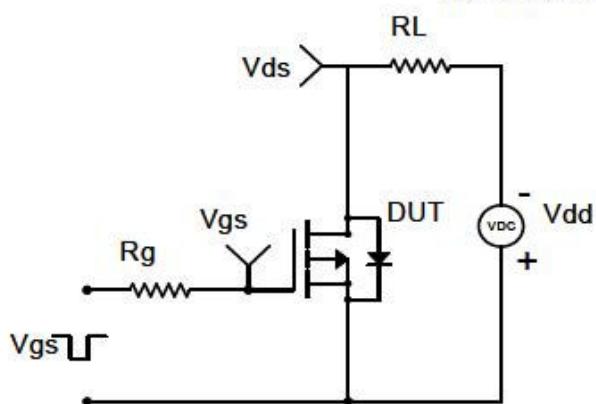
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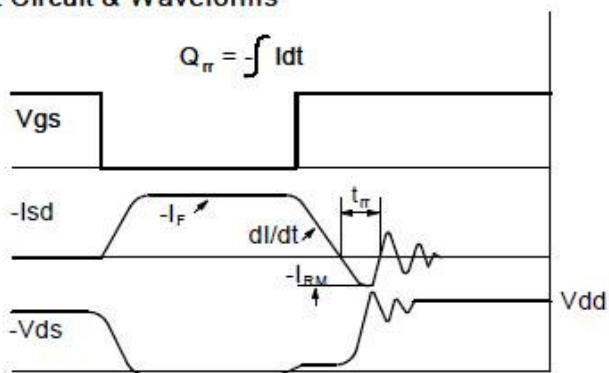
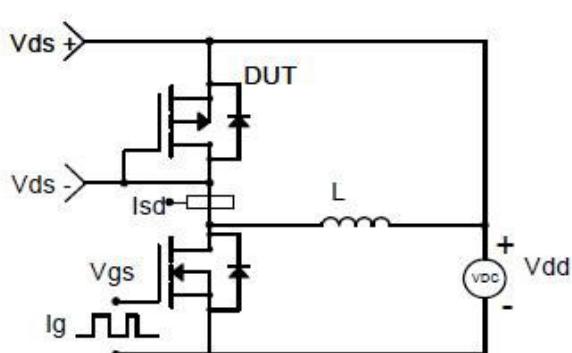
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

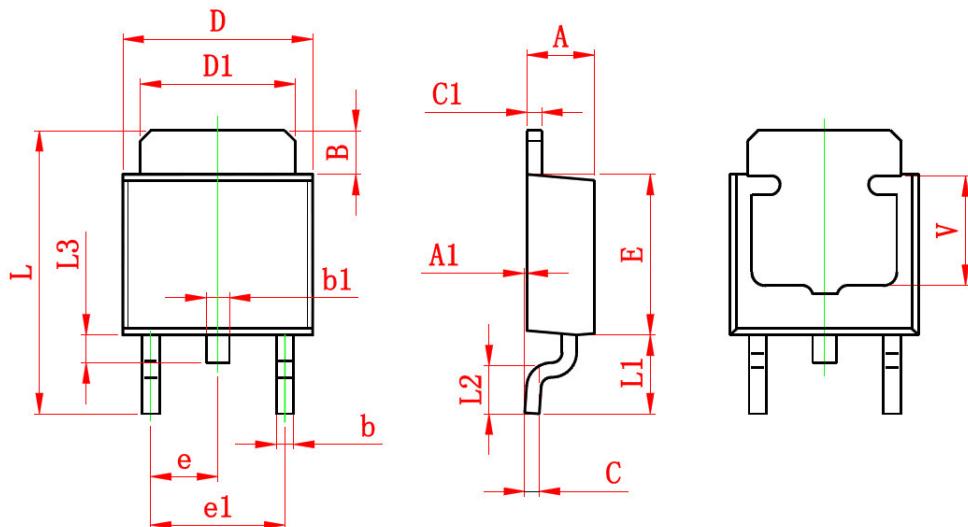




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**Package Information ( TO-252-2L )**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300 TYP.		0.091 TYP.	
e1	4.500	4.700	0.177	0.185
L	9.500	9.900	0.374	0.390
L1	2.550	2.900	0.100	0.114
L2	1.400	1.780	0.055	0.070
L3	0.600	0.900	0.024	0.035
V	3.800 REF.		0.150 REF.	

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